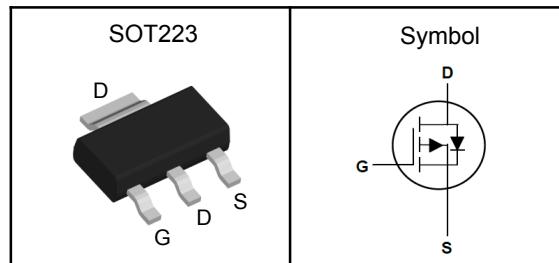


## P-Channel Enhancement Mode MOSFET

### Features

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant
- 100% UIS and Rg Tested

### Pin Description



### Applications

- Motor drivers
- DC - DC Converter

$V_{DSS}$	-100	V
$R_{DS(ON)-Typ}$	185	$\text{m}\Omega$
$I_D$	-2.6	A

### Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ , Unless Otherwise Noted)

Symbol	Parameter	P-Channel	Unit
$V_{DSS}$	Drain-Source Voltage	-100	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	V
$T_J$	Maximum Junction Temperature	-55 to 150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$I_{DM}^{①}$	Pulse Drain Current Tested	-10.4	A
$I_D$	Continuous Drain Current	$T_A=25^\circ\text{C}$	A
$I_D$	Continuous Drain Current	$T_A=70^\circ\text{C}$	A
$P_D$	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	W
$E_{AS}$	Avalanche Energy, Single pulse	12	$\text{mJ}$

### Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{θJA}$	Thermal Resistance Junction-Ambient <sub>1</sub> (Max)	50	$^\circ\text{C}/\text{W}$
$R_{θJC}$	Thermal Resistance Junction-Case <sub>1</sub>	15	$^\circ\text{C}/\text{W}$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C.

Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz.

## P-Channel Enhancement Mode MOSFET

**Electrical Characteristics** ( $T_J=25^\circ\text{C}$ , Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
<b>Static Electrical Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=-250\mu\text{A}$	-100	---	---	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-80\text{V}$ , $V_{\text{GS}}=0\text{V}$	---	---	-1	$\mu\text{A}$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_D=-250\mu\text{A}$	-1.0	---	-3	V
$I_{\text{GSS}}$	Gate Leakage Current	$V_{\text{GS}}=\pm20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm100$	$\text{nA}$
$R_{\text{DS(ON)}}$	Drain-Source On-state Resistance	$V_{\text{GS}}=-10\text{V}$ , $I_D=-2\text{A}$	---	185	225	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$ , $I_D=-1\text{A}$	---	190	245	$\text{m}\Omega$
<b>Dynamic Characteristics<sup>⑤</sup></b>						
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=-5\text{V}$ , $I_D=-2\text{A}$	---	6	---	S
$C_{\text{iss}}$	Input Capacitance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=-25\text{V}$ , Freq.=1MHz	---	1410	---	pF
$C_{\text{oss}}$	Output Capacitance		---	50	---	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	40	---	
$T_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DS}}=-50\text{V}$ , $V_{\text{GS}}=-10\text{V}$ , $R_G=1\Omega$ , $I_D=-2\text{A}$	---	6.6	---	nS
$T_r$	Turn-on Rise Time		---	18	---	
$T_{\text{d(off)}}$	Turn-off Delay Time		---	120	---	
$T_f$	Turn-off Fall Time		---	46	---	
$Q_g$	Total Gate Charge	$V_{\text{DS}}=-80\text{V}$ , $V_{\text{GS}}=-10\text{V}$ , $I_D=-2\text{A}$	---	25	---	nC
$Q_{\text{gs}}$	Gate-Source Charge		---	3.4	---	
$Q_{\text{gd}}$	Gate-Drain Charge		---	3.8	---	
<b>Source-Drain Characteristics</b>						
$V_{\text{SD}}^{④}$	Diode Forward Voltage	$I_S=-2\text{A}$ , $V_{\text{GS}}=0\text{V}$	---	---	-1.3	V
$I_S$	Continuous Source Current <sup>1</sup>		---	---	-2.6	A
$t_{\text{rr}}$	Reverse Recovery Time	$V_{\text{GS}}=0\text{V}$ , $I_S=-2\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$ , $T_J=25^\circ\text{C}$	---	18	---	nS
$Q_{\text{rr}}$	Reverse Recovery Charge		---	15	---	nC

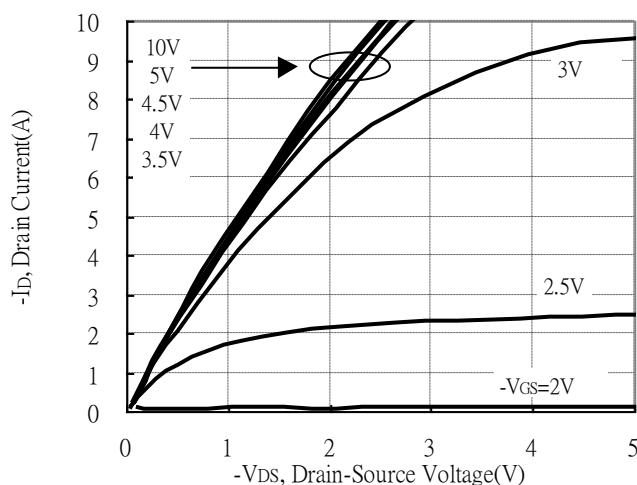
Note ④ : Pulse test (pulse width $\leq300\mu\text{s}$ , duty cycle $\leq2\%$ ).

Note ⑤ : Guaranteed by design, not subject to production testing.

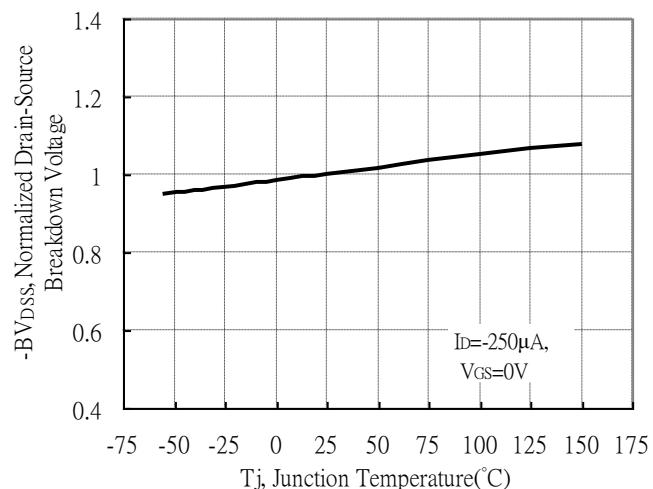
## P-Channel Enhancement Mode MOSFET

### Typical Characteristics

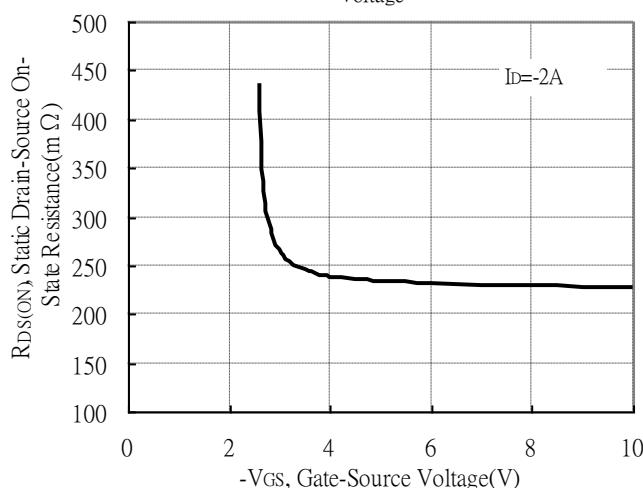
Typical Output Characteristics



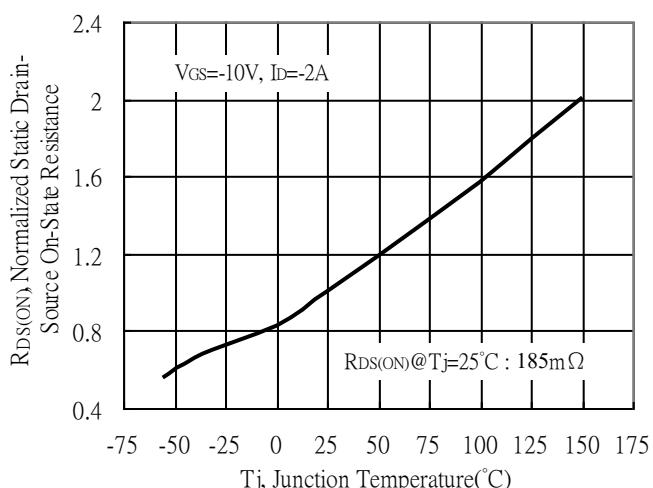
Breakdown Voltage vs Ambient Temperature



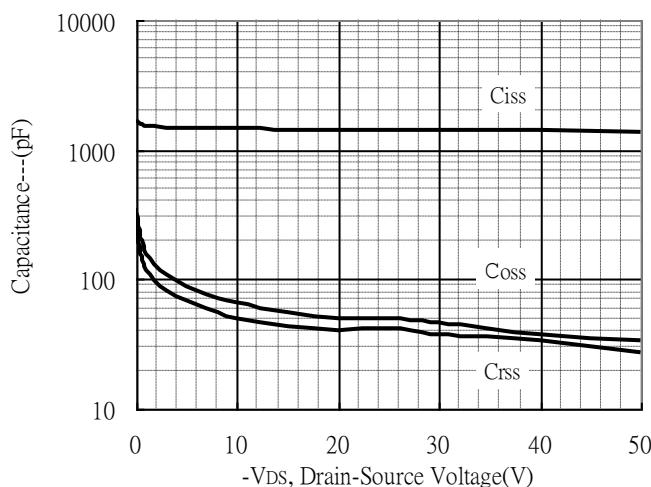
Static Drain-Source On-State Resistance vs Gate-Source Voltage



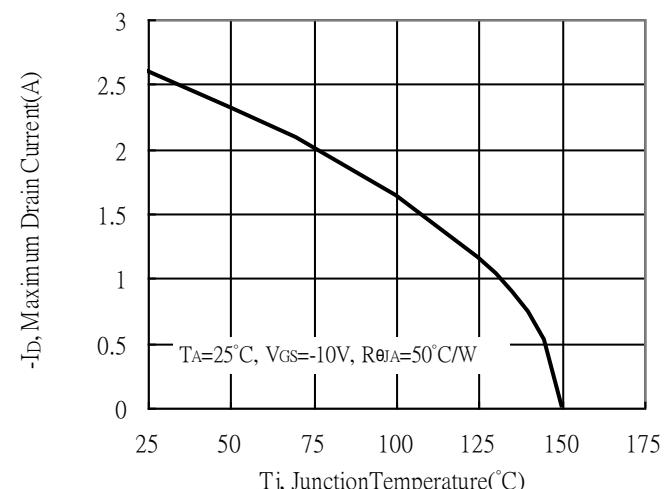
Drain-Source On-State Resistance vs Junction Temperature



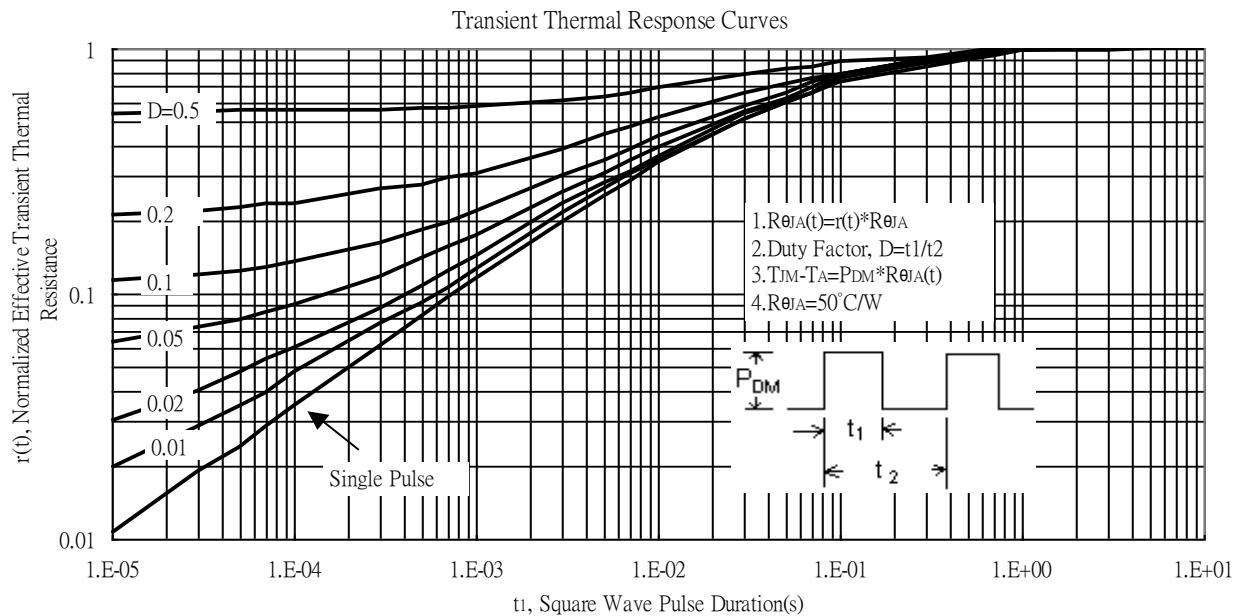
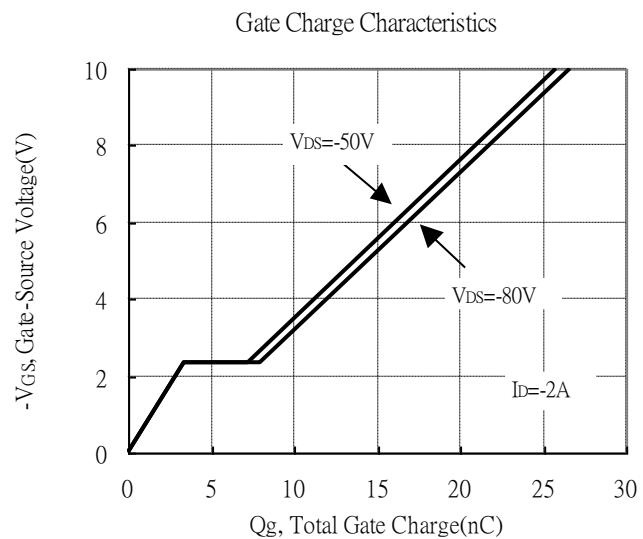
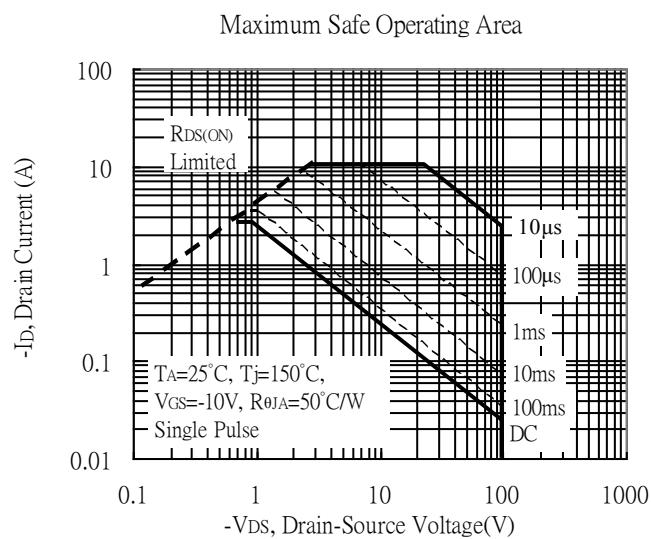
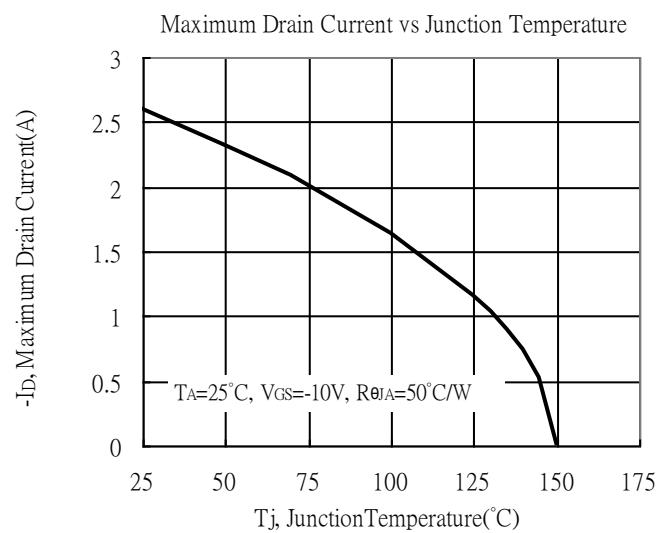
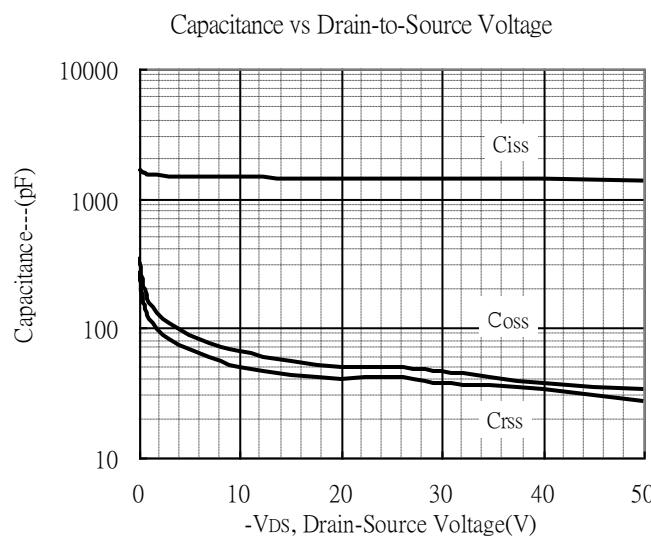
Capacitance vs Drain-to-Source Voltage



Maximum Drain Current vs Junction Temperature

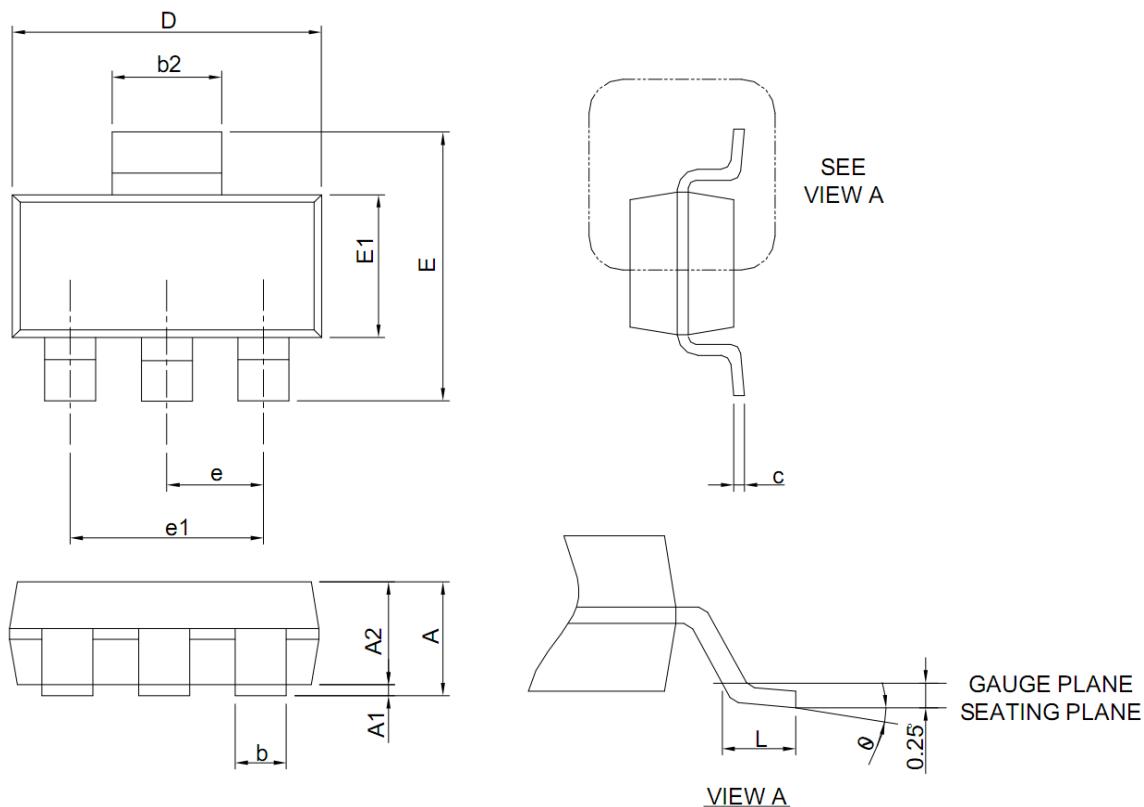


## P-Channel Enhancement Mode MOSFET



## P-Channel Enhancement Mode MOSFET

### SOT223 Package Outline Data



Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
A	1.50	1.65	1.80	A1	0.02	0.06	0.10
A2	1.50	1.60	1.70	b	0.66	0.72	0.80
b2	2.90	3.00	3.10	c	0.23	0.30	0.35
D	6.30	6.50	6.70	E	6.70	7.00	7.30
E1	3.30	3.50	3.70	e	2.30 REF		
e1	4.60 REF			L	0.75	--	1.15
θ	0°	--	10°				